In-Memory Computation of a Machine-Learning Classifier in a Standard 6T SRAM Array

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Abstract—This paper presents a machine-learning classifier where computations are performed in a standard 6T SRAM array, which stores the machine-learning model. Peripheral circuits implement mixed-signal weak classifiers via columns of the SRAM, and a training algorithm enables a strong classifier through boosting and also overcomes circuit nonidealities, by combining multiple columns. A prototype 128 × 128 SRAM array, implemented in a 130-nm CMOS process, demonstrates ten-way classification of MNIST images (using image-pixel features downsampled from 28 × 28 = 784 to 9 × 9 = 81, which yields a baseline accuracy of 90%). In SRAM mode (bit-cell read/write), the prototype operates up to 300 MHz, and in classify mode, it operates at 50 MHz, generating a classification every cycle. With accuracy equivalent to a discrete SRAM/digital-MAC system, the system achieves ten-way classification at an energy of 630 pJ per decision, 113 times lower than a discrete system with standard training algorithm and 13 times lower than a discrete system with the proposed training algorithm.

Index Terms—Analog computation, classification, image detection, in-memory computation, machine learning.

I. INTRODUCTION

MACHINE-LEARNING algorithms enable data-driven models for inference, and are thus playing an important role in sensing applications where correlations between embedded signals and inferences of interest are complex and difficult to model analytically. In many such applications, there is the need for always-on sensing and inference, so that systems can respond as specific events of interest occur. The challenge is that the state-of-the-art machine-learning models can be complex, requiring several millijoules of energy per decision [1]–[3]. An alternative is the approach in Fig. 1. Here, an ultralow-energy detector, still employing machine-learning models to address the complex correlations, provides what we refer to as a coarse detector to selectively activate a full-functioned node (note, the sensor energy shown [4] may also be reduced, for instance by accessing only a subset of the imager pixels required for coarse detection).

Looking at the energy for such detection shows that memory accessing can dominate. The reason is that data-driven models often do not have compact parametric representations, and their access from even modest-sized memories poses orders of magnitude higher energy than computation (e.g., 20–100 pJ per access of a 16-b word from 32 kB to 1 MB memory versus 1 pJ per multiply, in 45-nm CMOS [5]). An underlying limitation emerges in current architectures for digital accelerators, which separate data storage from computation. Storing the data fundamentally associated with a computation requires area, and thus, its communication to the location of computation incurs energy and throughput cost, which can dominate. This has motivated thinking about architectures that integrate some forms of memory and compute [6]–[10]. This paper presents a machine-learning classifier where data storage and computation are combined in a standard 6T SRAM [10], overcoming this limitation.

This paper is organized as follows. Section II provides an overview of the in-memory-classifier architecture. Section III presents the algorithm for training the classifier, particularly to overcome circuit limitations. Section IV presents circuit-level design details, and Section V presents prototype measurement and application-demonstration results. Finally, Section VI analyzes the proposed architecture with respect to the fundamental limitation identified above for traditional digital accelerators, and Section VII concludes this paper.

II. SYSTEM OVERVIEW

Fig. 2 shows the architecture of the proposed in-memory classifier. It consists of a standard 6T bit-cell array, and periphery for two modes of operation: In the SRAM mode, the operation is typical read/write of digital data. This is how machine-learning models derived from training are stored in bit cells. In the Classify Mode, all wordlines (WLs) are driven at once to analog voltages. Thus, parallel operation of all bit cells is involved (by comparison, and in the SRAM mode, only one WL is driven at a time). Each analog WL voltage corresponds to a feature in a feature vector we wish to classify. The features are provided as digital data, loaded through the

Fig. 1. Architecture for always-on sensing and inference, based on a low-energy coarse detector to trigger a full-functioned node.
feature-vector buffer, and analog voltages are generated using a WLDAC in each row.

In the Classify Mode, each SRAM column forms a weak classifier. In machine learning, a weak classifier is one that cannot be trained to fit arbitrary data distributions, and a strong classifier is one that can be. Due to fitting errors, a weak classifier typically has low performance in real-world application. For example, a linear classifier is a weak classifier, because it only implements linear decisions boundaries in a feature space, where generally feature data may take on complex distributions. On the other hand, a strong classifier (e.g., support-vector machine with radial-basis-function kernel) can form arbitrary decision boundaries for separating such data distributions. Thus, a strong classifier is ultimately required; but, below, the operation of the column-based weak classifier is first described.

A. Column-Based Weak Classifier

In a standard linear classifier, computation of a decision $d$ is shown in 1, where $x_i$ corresponds to elements from a feature vector $\vec{x}$, and $w_i$ corresponds to weights in a weight vector $\vec{w}$, derived from training

$$d = \text{sgn} \left( \sum_{i=1}^{N} w_i \times x_i \right).$$  

(1)

As shown in Fig. 3, in the Classify Mode, each column of the SRAM performs a similar computation. First, the bit-line pair (BL/BLB) is precharged. Then, the WLs are driven with analog voltages representing the feature values $x_i$, leading to corresponding bit-cell currents $I_{BC,i}$. Each $I_{BC,i}$ is applied to either BL or BLB depending on the data stored in the bit cell. Thus, treating BL/BLB as a differential voltage signal, the stored data can be thought of as multiplying a feature value (represented as $I_{BC,i}$), by a weight of $-1$ or $+1$, respectively. Finally, currents from all bit cells are summed together on BL/BLB resulting in aggregated discharge, and a comparator provides sign thresholding.

Thus, the structure operates as a classifier, but one that is even weaker than a linear classifier, because the bit-cell currents are nonideal (due to variation and nonlinearity) and the weights are restricted to $+/-1$. Section III presents a machine-learning algorithm for achieving a strong classifier, specifically addressing these points.

III. CLASSIFIER TRAINING

A specialized training algorithm is required to address the nonidealities of the column-based weak classifiers. Boosting [11] is an approach from machine learning for constructing a strong classifier from multiple base weak classifiers. In addition to the typical problem that boosting addresses, namely overcoming errors due to inadequate fitting of the weak classifiers, the column-based classifiers raise two additional challenges. First, their substantial circuit nonidealities (bit-cell variations and nonlinearities) cause classification outputs to deviate from those expected of even a nominal weak classifier. Second, while a column-based classifier is similar to a linear classifier with weights restricted to 1-b (Section II-A), standard linear-classifier training algorithms followed by such extreme quantization would lead to inadequate performance. Sections III-A and III-B describe the training algorithm, starting with a boosting algorithm to overcome circuit nonidealities, followed by a base-classifier training algorithm to overcome the very low weight precision.

A. Error-Adaptive Classifier Boosting

Error-adaptive classifier boosting (EACB) [12] is an approach that extends from Adaptive Boosting (AdaBoost) [11]. In AdaBoost, base weak classifiers are trained iteratively, at each stage biased to emphasize and correct fitting errors from the previous iterations (which arise due to a decision boundary not adequately separating training data from different classes). EACB performs training using the specific nonideal instances of implemented weak classifiers to bias each stage of training. Thus, errors due to

the nonideal implementation are adaptively corrected along with fitting errors.

Once all base weak classifiers are thus trained, the strong classifier is constructed via weighted voting over weak-classifier decisions. Fig. 4(a) shows the logical structure, and Fig. 4(b) shows its implementation, using multiple column-based weak classifiers for boosting and weighted voting over these outside the SRAM. It is expected that circuit nonidealities will increase the number of column-based weak classifiers required; this will be shown in the measurement results in Section V-B. Note that all weak classifiers take the same required; this will be shown in the measurement results in Section V-B. Note that all weak classifiers take the same

\[ \text{minimize} \sum_{s} (y_s - \alpha \cdot \vec{w} \cdot \vec{x}_s)^2 \]

subject to \( \alpha > 0, \quad \vec{w} \in \{-1, 1\}^N \). (2)

Unlike conventional linear regression, this optimization is discretized and not convex, with complexity scaling exponentially in the vector dimensionality \( N \). However, as shown in (5), by pulling \( \alpha \) scaling into the constraints (such that \( \vec{w} = \alpha \cdot \vec{\omega} \)), as well as introducing binary variables \( b_i \) (to be optimized) and a constant \( c \) [simply chosen to be larger than \( \alpha + \max(|y_i|) \)], reformulation to a mixed-integer program is possible (i.e., quadratic objective and linear constraints). For this, fast solvers such as [13] are available

\[ \text{minimize} \sum_{s} (y_s - \tilde{\omega} \cdot \vec{x}_s)^2 \]

subject to \( \alpha \leq v_i \leq \alpha, \quad v_i + c \cdot b_i \geq \alpha, \quad v_i + c \cdot (b_i - 1) \leq -\alpha \)

where \( b_i \in \{0, 1\}, \quad c > \alpha + \max(|y_i|), \quad i = 1, \ldots, N \). (4)

Fig. 5 illustrates this approach in an MNIST [14] digit-recognition application, for a 0-versus-2 classifier using 81 image-pixel features (downsampled from 784, and projected to two dimensions using PCA for visualization). The decision boundary for a linear classifier with weights quantized to 10-b retains high accuracy of 96%. Decision boundaries from 1-b weights correspond to 45\(^1\) lines in the 2-D feature space, with simple quantization leading to a low accuracy

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1 This represents a relatively difficult classification due to similar shape of the hand-written digits.
of 52%. On the other hand, 1-b quantization using the optimization above substantially restores accuracy to 91% (we point out that the separability in an 81-D feature space is better than that actually seen in the 2-D projection).

Fig. 6 overviews the training approach, using training accuracy for various base classifiers in an MNIST [14] 0–9 digit-recognition application (error bars show min/max accuracy over 45 required binary classifiers for all pairs of digits). First, it is the performance of a linear classifier trained via linear regression, using 64-b floating-point weights. Next, it is a classifier with weights quantized to 10-b (found to be the limit before accuracy substantially degrades). Then, it is a classifier with further weight quantization to 1-b, showing poor accuracy. After this, it is the performance of a classifier using 1-b weights from the optimization above, showing significantly higher accuracy. All classifiers thus far represent ideal implementation, simulated in MATLAB. The last bar shows the measured accuracy of column-based classifiers from the implemented prototype. We see degradation due to circuit nonidealities, showing that EACB is critical for restoring accuracy to the level of the ideal system.

IV. CIRCUIT DESIGN

This section presents the details of the circuit design and its analysis.

A. Wordline DAC

Fig. 7 shows the WLDAC circuit. The 5-b digital feature values $X[4 : 0]$ are inputted to a current DAC, formed from binary-weighted pMOS current sources. The resulting current $I_{DAC}$ is converted into an output WL voltage by running it through an upsized replica of a bit cell. The driver-transistor replica $M_{D,R}$ receives a $V_{DD}$ gate bias when Classify Mode is enabled (via $CLASS\_EN$), thus representing a pull-down condition in a bit cell. The access-transistor replica $M_{A,R}$ is self-grown to generate a WL voltage corresponding to the DAC current. Consequently, $I_{DAC}$ is mirrored by the bit cell, giving roughly linear $I_{BC}$ with the inputted digital feature value (scaled by the upsizing ratio $R$), and tracking with voltage, temperature, and process skews is achieved.

With regard to error sources, we see from Fig. 8(a) that the WL settling time is variable. This is due to self-biasing of the bit-cell replica (i.e., DAC output impedance ~ $1/gm_{A,R}$ depends $I_{DAC}$). Thus, at low currents, driving the large WL capacitance exhibits slewing behavior. This leads to a source of nonlinearity, as shown in the BL-discharge transfer function of Fig. 8(b). To mitigate this, an offset current source is included in the DAC (i.e., pMOS devices on the far right in Fig. 7) to reduce its output impedance, and the current source is enabled irrespective of the digital input code. As seen, this notably improves the transfer-function linearity.

Some remaining nonlinearity is observed, but is addressed by EACB. Strictly speaking, nonlinearity poses a systematic
source of error across all weak classifiers, not accounted for in the learning rule. Thus, even if the model derived at each iteration of training is appropriately adapted, a consistent nonlinearity in applying the model at every iteration will prevent the errors from being corrected (and a change in the learning rule to account for the nonlinearity will be required [17]). However, if variations dominate the nonlinearity, the errors will not be consistent across iterations, and will be corrected over the iterations [12]. Error bars in Fig. 8(b), representing the standard deviation (from Monte Carlo simulations), show that this is the case.

Yet another source of error arises due to bit-line discharge. The transfer function in Fig. 8(b) assumes that BL/BLB remains near their precharge voltage. However, unlike the SRAM mode where low-swing BL/BLB is preferred, in the Classify Mode, large BL/BLB swings are allowed to accommodate the dynamic range needed for summation of all bit-cell pull-down currents. This introduces two sources of error: 1) the currents from all cells pulling down are reduced due to decreasing $V_{DS}$ across their access and driver transistors and 2) cells not pulling down begin to pull up, albeit through a weakly biased nMOS. As shown in Fig. 9(a), this occurs because the access transistors experience reducing source voltage and begin to turn on. Consequently, as shown in the simulations of Fig. 9(b), a lower common-mode voltage causes the BL/BLB differential voltage to be compressed. However, we note that in absence of comparator offset, this does not change the sign and thus the result of classification. Furthermore, because comparator offset is expected to be uncorrelated between column-based weak classifiers, EACB can overcome such errors. Additionally, Section IV-C describes a method by which comparator offsets are compensated.

### B. Bit Cells

The bit-cell array is identical to a standard 6T SRAM, including sizing. We note that in the Classify Mode, the cells face the potential for a new upset condition. However, this exhibits much greater margin than the standard SRAM Mode. Fig. 10(a) shows the read condition during the SRAM Mode. An upset could occur because the stored data are exposed to precharged BL/BLB, which can pull up the internal nodes. To ensure the stored data are retained, the butterfly curves shown in Fig. 10(b) must exhibit bistable lobes; the read static noise margin (SNM) measures the size of the largest embedded square in these lobes [18]. On the other hand, Fig. 11(a) shows a condition, similar to SRAM write, which could occur during the Classify Mode. Namely, BL/BLB can be pulled low, potentially causing an internal node at Logic 1 to be pulled low. However, because the WL is restricted to $<0.4\text{V}$ [Fig. 8(a)], the internal nodes are minimally affected, and as seen in the butterfly curves of Fig. 11(b), large “Classify SNM” is maintained. Fig. 12 shows distributions from Monte Carlo simulations of the SRAM Mode read SNM and the Classify Mode SNM, showing that Classify Mode has much larger margin and lower standard deviation.
C. Sense Amplifiers

Fig. 13(a) shows the sense-amplifier comparator used for each column. Unlike in a standard SRAM, which employs low-swing BL/BLB, the sense amplifier must accommodate rail-to-rail inputs that can occur in the Classify Mode. Thus, a topology is used based on back-to-back inverters for regeneration, where the coupled nodes are driven by BL/BLB. As shown in Fig. 13(b), the timing is designed, such that the input switches are turned on just before the precharge phase ends. This way, precharging BL/BLB also equalizes charge on the regenerative nodes before the discharge phase begins.

Comparator offset, like many other circuit nonidealities, can be overcome via EACB. But, the SRAM structure readily affords self-compensation to substantially reduce comparator offset, thus reducing the EACB iterations required (as demonstrated in Section V-B). This is done in Fig. 14. C rows are designated for offset compensation, with a WL bias $V_{\text{CAL}}$ set to achieve a desired granularity of compensation (in the figure, $C = 8$ but tests in Section V-A employ $C = 32$). Since comparator offset can be dependent on the input common-mode level, other rows are designated for discharging BL/BLB to nominally equivalent values corresponding to the average discharge level expected during operation. Initially, half of the offset-compensation rows are set to store a Logic 1, and half are set to store a Logic 0. Then, BL/BLB discharge is performed and a comparison is made. For columns that return a $-1$ decision, half of the Logic 0 cells are written with Logic 1 data, and for columns return a $+1$ decision, half of the Logic 1 cells are written with Logic 0 data. Progressing in this way via binary search, the offset of all columns can be compensated in parallel with $\log_2 C$ cycles. In reality, equivalent discharge of BL/BLB to the expected common-mode level will be subject to bit-cell variations. To mitigate this, each binary-search decision can be made by averaging the comparison output over various configurations of discharge rows; in the tests of Section V-A, averaging over ten different discharge-row configurations is employed. The overhead of offset compensation is the number of rows required (adding area and bit-line capacitance), which sets the ratio of the offset-compensation range and granularity (i.e., small $V_{\text{CAL}}$ gives finer granularity but reduces range, requiring more rows). However, because all rows are physically identical, the number of rows employed for offset compensation can be configured to optimize for different applications.

V. Prototype Measurements

A prototype is developed in 130-nm CMOS with a $128 \times 128$ 6T bit-cell array supporting both SRAM and Classify Mode operation. For testing, write data, read data, and feature vectors are provided via buffers, implemented as scan chains. The die photo and measurement results are summarized in Fig. 15.

A. IC Characterization

SRAM Mode operates at 300 MHz while Classify Mode operates at 50 MHz, with an energy per clock cycle of 14.7 and 46.6 pJ, respectively. The bit cells employ standard sizing of transistors, but are laid out with logic rules, thus yielding a cell size somewhat larger than high-density 130-nm 6T cells. The periphery layout is optimized for testability, but the added periphery circuits (most notably WLDACs) occupy roughly the same area of the standard SRAM periphery (address decoder and WL drivers).

Comparator offset before and after compensation is measured by sweeping the differential BL/BLB voltage (around the expected common-mode level). This is done by sweeping the WLDAC codes of rows configured to discharge BL/BLB. As in the case of the common-mode level, the differential BL/BLB voltage attained this way is subject to bit-cell variations. Thus, averaging is performed over various configurations of rows. Fig. 16 shows the measured offset across 128 columns from
Fig. 16. Result of offset compensation, showing the standard deviation of comparator offset can be reduced.

Fig. 17. Implementation of demonstration system for classifying 0–9 handwritten numerical data from MNIST data set. one chip, where 32 offset-compensation rows are employed with a granularity $V_{\text{CAL}}$ set by a WLDAC code of $5'b01000$. The measured offset standard deviation is 54 LSB before compensation and 13 LSB after compensation. As shown next, this significantly reduces the number of EACB iterations required.

B. System Demonstration

For application demonstration, image recognition of handwritten numerical digits (0–9) from the MNIST data set [14] is performed, with features corresponding to raw pixel values. However, MNIST images have $28 \times 28 = 784$ pixels. Since the prototype implements only 128 rows, we low-pass filter and downsample the images to $9 \times 9 = 81$ pixels. MATLAB simulation of an ideal system based on boosted linear classifiers shows that the detection accuracy reduces from 96% to 90%. This now becomes the target for the system measurements, where 81 of the rows are used for feature inputs, 32 of the rows are used for offset compensation, and 15 rows are disabled (by setting the corresponding WLDAC inputs $X_{\text{offset}}$ and $X[4 : 0]$ to 0).

For ten-way digit classification, 45 binary classifiers are implemented for all pairs of digits, and all-versus-all (AVA) voting is performed over these. As shown in Fig. 17, the binary classifiers (each including multiple iterations for EACB) are implemented using SRAM columns, while the adders required for boosting (7-b) and AVA voting (16-b) are outside the array.

Fig. 18 shows the measured accuracy versus the number of EACB iterations. The conventional, ideal system (implemented in MATLAB), corresponding to boosted linear classifiers with 10-b weights (determined to be the limit before performance degrades), achieves convergence in three iterations. The ideal system with 1-b weights (implemented in MATLAB), corresponding to boosted linear classifiers trained using the proposed approach in Section III-B, is somewhat weaker and achieves convergence in five iterations. For both ideal systems, EACB is only correcting weak-classifier fitting errors, not circuit nonidealities. The prototyped system achieves the performance of the ideal systems with 18 EACB iterations, required to overcome circuit nonidealities. Thus, we see that this application is not a trivial example in the sense of being inherently tolerant to circuit nonidealities that impact the in-memory architecture. Finally, we also show the performance, over the first few iterations, of the prototyped system without comparator-offset compensation; boosting is still achieved, but more EACB iterations would be required for performance convergence. We note that the 18 iterations required correspond to more than 128 columns. Thus, the input feature data are replayed in multiple runs to obtain data from all required weak classifiers, 128 at a time (energy reported below is for all runs). Testing to several iterations was performed on multiple chips, all demonstrating very similar performance (e.g., testing to 18 iterations done for two chips showed accuracy >90%).

Fig. 19(a) shows the energy analysis. On the left, it is the estimated energy of a conventional, discrete SRAM/digital-MAC system, using boosted linear classifiers with 10-b weights, requiring 71 nJ per ten-way classification. Next, it is the estimated energy of a discrete SRAM/digital-adder system, with $+/−1$ weights from the proposed approach; it requires more iterations, but total energy is reduced to 7.9 nJ thanks to fewer SRAM accesses and simpler computations following. Next, it is the measured energy of the prototype; it requires more iterations still, but total energy is further reduced.
Fig. 19. Comparison of demonstrated system with discrete SRAM/digital-MAC systems showing (a) 113× and 13× energy reduction and (b) 1525× and 175× EDP reduction.

Fig. 20. Energy and delay scaling in traditional and in-memory architectures.

VI. ANALYSIS OF IN-MEMORY ARCHITECTURE

This section examines how the in-memory architecture alters the tradeoffs in traditional 2-D architectures, where separation of data storage and computation raises a communication cost, scaling with the amount (area) of data to be stored. Fig. 20 shows the two architectures (we point out that various other architectures, such as stacked 3-D, and computational models, such as neuromorphic computing, will raise alternate tradeoffs in terms of wire capacitance and bit-cell accessing patterns, impacting the tradeoffs analyzed). We assume that the amount of data required for a computation is \( D \) bits, arranged in a \( D^{1/2} \times D^{1/2} \) array, as is typically preferred. We identify the following metrics of interest: bandwidth, latency, energy, and SNR (though roughly fixed in traditional SRAMs, SNR plays prominently in the in-memory architecture). These are analyzed for the entire computation (i.e., over the entire data) as \( D \) increases.² Fig. 20 summarizes the analysis detailed as follows.

1) **Bandwidth:** Traditional architectures are limited to providing data to computational hardware at each cycle through a single memory port. While the port size can increase as \( D^{1/2} \), to access the full data, \( D^{1/2} \) cycles are required (i.e., number of rows), causing the total bandwidth to decrease accordingly. On the other hand, combining storage and computational hardware in the in-memory architecture affords massive parallelism, where all data are inherently available to the computational hardware.

2) **Latency:** In traditional architectures, the BL/BLB capacitance increases as \( D^{1/2} \) (causing proportional increase in discharge time), and the number of accesses increases as \( D^{1/2} \), resulting in latency scaling as \( D \). In the in-memory architecture, the BL/BLB capacitance increases similarly, but the number of bit cells pulling down in parallel increases proportionally, resulting in roughly constant absolute BL/BLB swing for given discharge time (BL/BLB differential voltage impacts SNR, as discussed in the following).

3) **Energy:** In traditional architectures, we assume the energy of BL/BLB discharge dominates. The increasing BL/BLB capacitance (as \( D^{1/2} \)), the increasing number of bit lines (as \( D^{1/2} \)), and the increasing number of accesses (as \( D^{1/2} \)) cause the energy to scale as \( D^{3/2} \). In the in-memory architecture, BL/BLB discharge also dominates, and further involves large swing. However, the number of accesses is constant, causing the energy to scale only as \( D \) (which is much lower than \( D^{3/2} \) for practical values of \( D \)). We point out that the in-memory architecture also drives all WLs at once, making the WL energy higher than in traditional architectures. However, the WL voltages are low (<0.4V, as seen in Fig. 8a), making this energy small, measured to be <20%.

4) **SNR:** Traditional SRAMs employ low-swing BL/BLB signaling set by sensing requirements, regardless of \( D \). On the other hand, for the in-memory architecture, the SNR for each weak-classifier decision varies, with the worst case set by a condition where an equal number bit cells pull down BL/BLB and only one additional bit cell pulls down either BL or BLB, setting the differential voltage. While the absolute discharge on BL/BLB is roughly constant with \( D \), the differential discharge decreases with the BL/BLB capacitance as \( D^{1/2} \), thereby reducing the effective signal for the classification decision. Though error sources due to device noise

²We note that for each column-based weak classifier, the fundamental amount of data is \( D^{1/2} \); this results in similar tradeoffs, but we focus on the ensemble classifier as a more relevant computation.
(e.g., thermal/shot noise) also reduce with capacitance (roughly as $D^{1/4}$), in practice, SNR is limited by other error sources (e.g., nonlinearities, offsets, and variations).

We see that the in-memory architecture alters the above tradeoffs, benefiting bandwidth, latency, and energy at the cost of SNR. This is preferred given the algorithmic approaches employed to address SNR (Section III). We note that taken to an extreme, this can eventually degrade efficiency (e.g., requiring many EACB iterations). But, an important and promising direction that emerges with ensemble classifiers is the ability to segment feature vectors, for instance by partitioning [19] or low-dimensional embedding [20], [21] of feature subspaces. This allows the data fundamentally associated with a particular weak classifier to be reduced, so $D$ can be segmented into subarrays (avoiding excessive SNR degradation due to increasing BL/BLB capacitance). Thus, algorithmic approaches can enable optimization of an in-memory implementation across all metrics for a broad range of data size and applications.

VII. CONCLUSION

This paper presents a strong machine-learning classifier implemented in a standard 6T SRAM array. Throughput is enhanced because operation is performed over all bit cells in a column at once, and energy is enhanced because this corresponds to only a single BL/BLB discharge (as compared with standard read/write, where operation is performed over only one bit cell in a column at once). The primary impact is reduced SNR of the computation, limited by circuit nonlinearities and weaker classifiers (i.e., lower precision weights). Training algorithms are introduced (for boosting and base-classifier training) to address this. A measured prototype demonstrating MNIST image classification shows that the algorithms are successful in restoring performance to the level of an ideal, discrete SRAM/digital-MAC system while lowering energy by $113 \times$ when a standard training algorithm is employed and by $13 \times$ when the proposed training algorithm is employed in the ideal, discrete systems.

REFERENCES

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